HALOGEN

FREE



Vishay General Semiconductor

Surface Mount Schottky Barrier Rectifiers

eSMP® Series Top view Bottom view DO-219AB (SMF)

PRIMARY CHARACTERISTICS			
I _{F(AV)}	2.0 A		
V _{RRM}	60 V		
I _{FSM}	40 A		
V _F at I _F = 2.0 A (T _A = 125 °C)	0.64 V		
T _J max.	175 °C		
Package	DO-219AB (SMF)		
Diode variations	Single die		

FEATURES

- Low profile package
- · Ideal for automated placement
- · Low forward voltage drop, low power losses
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- · Wave and reflow solderable
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: DO-219AB (SMF)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	SS2FH6	UNIT	
Device marking code		26		
Maximum repetitive peak reverse voltage	V_{RRM}	60	V	
Maximum average forward rectified current (fig.1)	I _{F(AV)} (1)	2.0	Α	
Peak forward surge current 8.3 ms single half sine-wave T _{J (init)} = 25 °C	I _{FSM}	40	А	
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175	°C	

Note

(1) Free air, mounted on recommended copper pad area



ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 1.6 A	- T _A = 25 °C		0.69	-	- V
	I _F = 2.0 A		V _F (1)	0.72	0.78	
	I _F = 1.6 A	- T _A = 125 °C	- V _F (1)	0.61	-	
	I _F = 2.0 A			0.64	0.69	
Reverse current	V 60.V	T _A = 25 °C	1 (2)	-	3	μΑ
	V _R = 60 V	T _A = 125 °C	- I _R ⁽²⁾ -	90	450	
Typical junction capacitance	4.0 V, 1 MHz		CJ	90	-	pF

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T _A = 25 °c unless otherwise noted)				
PARAMETER	SYMBOL	SS2FH6	UNIT	
Typical thermal resistance	R ₀ JA (1)(2)(3)	125	°C/W	
Typical thermal resistance	R _{0JM} (1)(2)(3)	21	- C/VV	

Notes

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta,JA}$
- (2) Device mounted on FR4 PCB, 2 oz. standard footprint
- $^{(3)}$ Thermal resistance $R_{\theta JA}$ junction to ambient; $R_{\theta JM}$ junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SS2FH6-M3/H	0.015	Н	3000	7" diameter plastic tape and reel
SS2FH6-M3/I	0.015	I	10 000	13" diameter plastic tape and reel
SS2FH6HM3/H (1)	0.015	Н	3000	7" diameter plastic tape and reel
SS2FH6HM3/I (1)	0.015	I	10 000	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified



RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

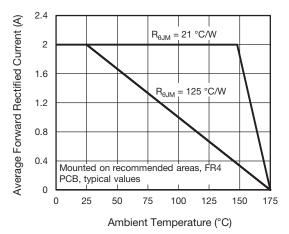


Fig. 1 - Maximum Forward Current Derating Curve

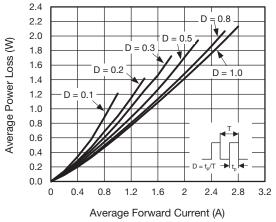


Fig. 2 - Average Power Loss Characteristics

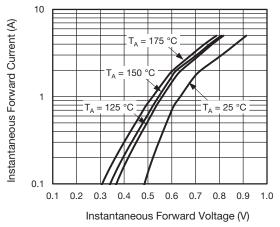


Fig. 3 - Typical Instantaneous Forward Characteristics

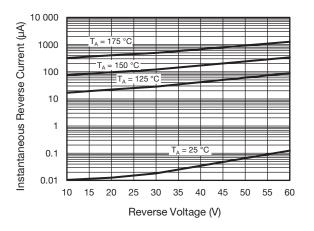


Fig. 4 - Typical Reverse Leakage Characteristics

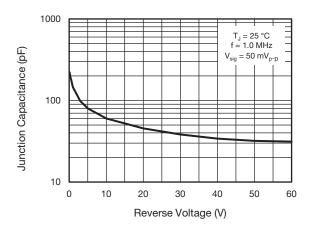


Fig. 5 - Typical Junction Capacitance

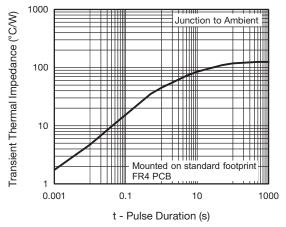
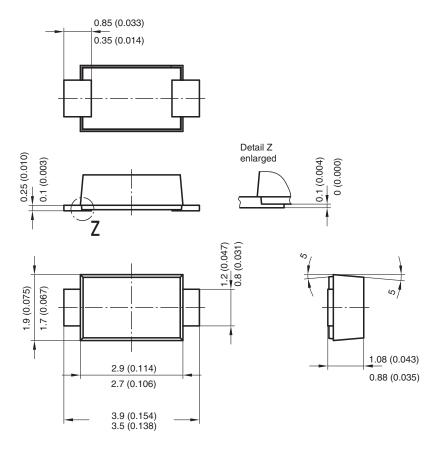
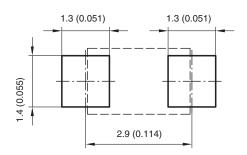


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in millimeters (inches)

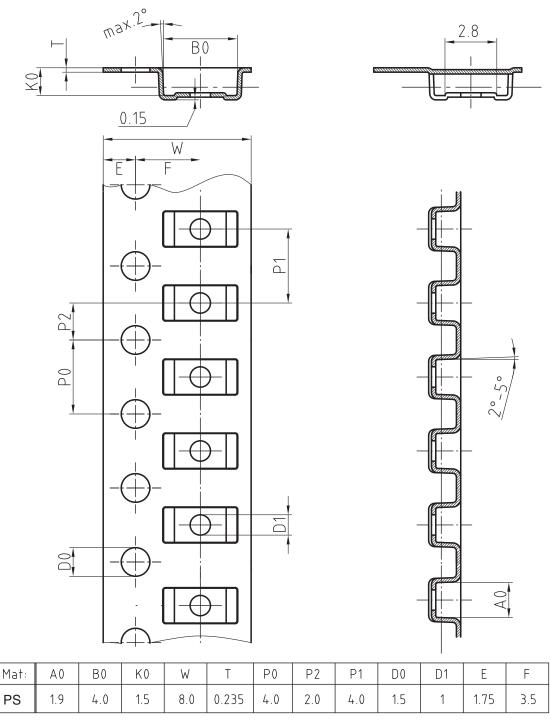


Foot print recommendation:



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BLISTERTAPE DIMENSIONS in millimeters: **DO-219AB (SMF)**



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18513



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